## 2SC5852

### Silicon NPN Epitaxial Planar

# **HITACHI**

ADE-208-1481 (Z)

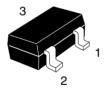
Rev.0 Feb. 2002

#### **Features**

• VHF amplifier, local oscillator

#### Outline

CMPAK



- 1. Emitter
- 2. Base
- 3. Collector



### **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit	
Collector to base voltage	V <sub>CBO</sub>	30	V	
Collector to emitter voltage	V <sub>CEO</sub>	20	V	
Emitter to base voltage	V <sub>EBO</sub>	4	V	
Collector current	I <sub>c</sub>	20	mA	
Collector power dissipation	P <sub>c</sub> *	150	mW	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

<sup>\*</sup>Value on the glass epoxy board (10 mm x 10 mm x 0.7 mm)

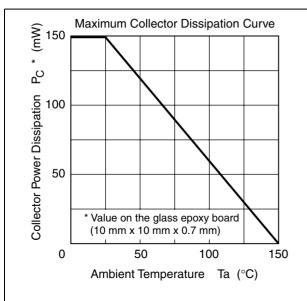
#### **Electrical Characteristics**

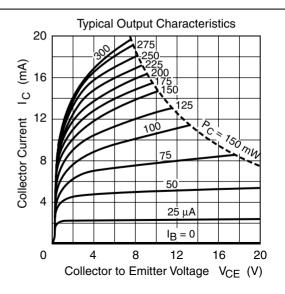
 $(Ta = 25^{\circ}C)$ 

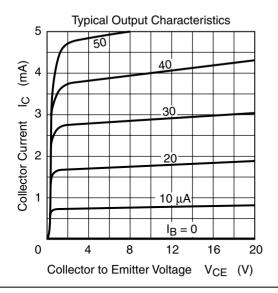
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{_{(BR)CBO}}$	30	_	_	V	$I_{c} = 10 \ \mu A, \ I_{e} = 0$
Collector to emitter breakdown voltage	$V_{_{(BR)CEO}}$	20	_	_	V	$I_{c} = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{_{(BR)EBO}}$	4	_	_	V	$I_{E} = 10 \mu A, I_{C} = 0$
Collector cutoff current	I <sub>CEO</sub>	_	_	0.5	μΑ	V <sub>CE</sub> = 10 V, R <sub>BE</sub> = ∞
Emitter cutoff current	I <sub>EBO</sub>	_	_	0.5	μΑ	$V_{EB} = 2 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub> *1	60	_	200	_	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	_	0.17	_	V	I <sub>C</sub> = 20 mA, I <sub>B</sub> = 4 mA
Base to emitter voltage	V <sub>BE</sub>	_	0.72	_	V	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$
Gain bandwidth product	f <sub>T</sub>	_	940	_	MHz	$V_{CE} = 6V$ , $I_{C} = 5$ mA
Collector output capacitance	C <sub>ob</sub>		0.9	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$

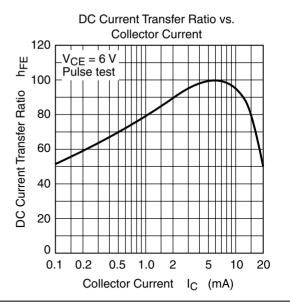
Notes: 1. The 2SC5852 is grouped by  $h_{\rm FE}$  as follows.

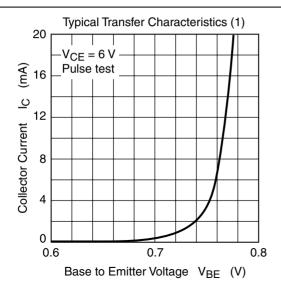
Grade	В	С
Mark	QB	QC
h <sub>FE</sub>	60 to 120	100 to 200

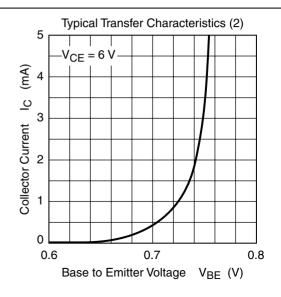


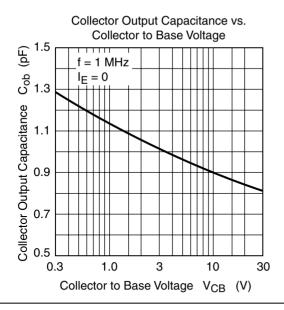


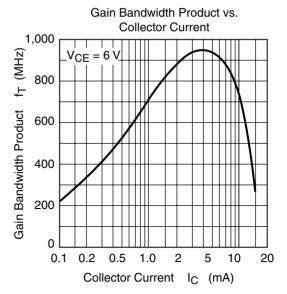




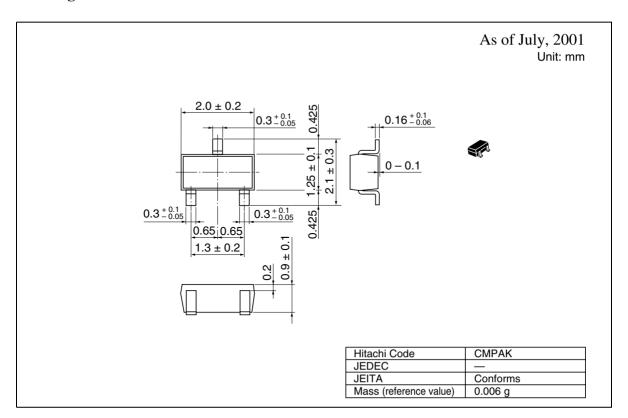








### **Package Dimensions**



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